

## **SPECIFICATION SHEET**

SPECIFICATION SHEET NO.	Q0501-CM10M00000S030
DATE	May 01, 2023
REVISION	A0
DESCRIPITION	SMD Ceramic Resonator, 3731 Type, L3.7*W3.1*H1.5mm,
	Built-in Capacitance, 3 pads, CRTV Series
	10.000MHz, Frequency Accuracy +/-0.5%,
	Operating Temp. Range -25°C ~+85°C,
	Reflow Profile Condition 260 °C Max.
	RoHS/RoHS III compliant, Tape/Reel
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	TGS CRTV 10.0MT-30 TLF
PART CODE	CM10M0000S030

### **VENDOR APPROVE**

Issued/Checked/Approved





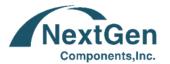


DATE: May 01, 2023

CUSTOMER APPROVE
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DATE:

5/4/2023



### **SMD CERAMIC RESONATOR CRTV SERIES**

#### MAIN FEATURE

- SMD Ceramic Resonator, L3.7\*W3.1\*H1.5mm, 3 pads
- Low cost & Built-in Capacitance
- Reflow Profile Condition 260 °C Max.
- Wide Frequency Range
- Cross more competitors part
- RoHS III compliant

### **APPLICATION**

- Bluetooth, wireless communication set
- Communication Electronics

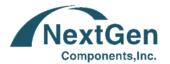
## PART CODE GUIDE



СМ	10М00000	S	030
1	2	3	4

- 1) CM: Part Code for SMD Ceramic Resonator, Built-in Capacitance, L3.7\*W3.1\*H1.5mm, 3 pads, CRTV series
- 2) 10M00000: Frequency range code for 10.00000MHz
- 3) S: SMD type, Package Tape/Reel, 1000pcs/Reel
- 4) 030: Specification code for original part No.: TGS CRTV 10.0MT-30 TLF

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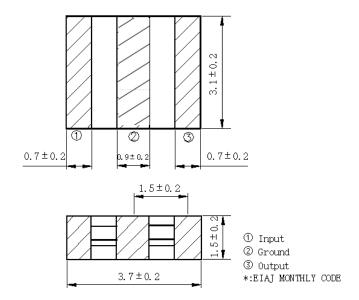
# **SMD CERAMIC RESONATOR CRTV SERIES**

### **DIMENSION (Unit: mm)**

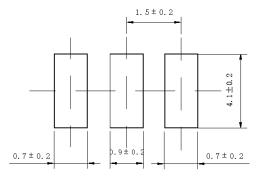
### Image for reference



**CRTV** 



### **Recommend Pad Layout**



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# **SMD CERAMIC RESONATOR CRTV SERIES**

### **ELECTRICAL PARAMETERS**

Parame	ter	Part No.	Units	Value		Condition	
		Symbol		Min.	Typical	Max.	_
Original	Manufacturer	TGS		TGS	Crystals		
Holder 1	Гуре	CRTV	SMD Ceram	ic Resonator	, L3.7*W3.1*H1.3n	nm, 3 pads	
Frequen	ncy Range	10.0	MHz		10.0		
Withsta	nding Voltage	MT	V	50			@DC, 1 min
Insulatio	on Resistance		МΩ	500			@AV, 1 min.
Operation	on Temperance		°C	-25		+85	
Storage	Temperance		°C	-55		+85	
Rating V	/oltage		V	6			DC
					15		р-р
Frequen	ncy Accuracy		%	0.5			
Resonar	nt Impedance		Ω			40	
Tempers of Oscill Frequen			%			+/-0.3	Oscillation Frequency drift, -25°C ~ +85°C)
	on Frequency ate (10 years)		%			+/-0.3	From initial value
IC applic	cation			1/6TC74HCU04Px2			
Design I	Mode						
Built-in	Capacitance	-30	pF 30pF (+/-20%)				
	Package T Tape/Reel						
	RoHS Status	LF		RoHS I	II compliant		_
Other	Add Value				N/A		
	Internal Control Code *			N/A			

Note: 1) Original Part Number: TGS CRTV 10.0MT-30 TLF

2) \* Internal Control Code- 2 letter or digits; Blank: N/A

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# **SMD CERAMIC RESONATOR CRTV SERIES**

### **RELIABILITY**

Test Items	Test Method And Conditions	Performance Requirements
Humidity	Keep the resonator at 40°C±2°C and 90%-95% RH for 96h. Then Release the resonator into the room Condition for 1h prior to the Measurement.	It shall fulfill the specifications in Table 1.
High Temperature Exposure	Subject the resonator to -85°C±2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Low Temperature Exposure	Subject the resonator to -55°C $\pm$ 2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Temperature Cycling	After temperature cycling of blow table was performed 5 times, resonator shall be measured after being placed in natural conditions for 1h. Time: 30 min.@ -25 +/-3°C; Time: 30 min. @85 +/-3°C	It shall fulfill the specifications in Table 1.
Vibration	Subject the resonator to vibration for 2h each in x, y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.	It shall fulfill the specifications in Table 1.
Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.	It shall fulfill the specifications in Table 1.
Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1h before measurement	It shall fulfill the specifications in Table 1.
Solder Ability	Dipped in 245°C±5°C solder bath for 3s±0.5 s with rosin flux (25wt% ethanol solution.)	The terminals shall be at least 95% covered by solder.
Board Bending	Mount a glass-epoxy board (Width=40mm,thickness=1.6mm),then bend it to 1mm displacement and keep it for 5s. (See the following figure 1)	Mechanical damage such as breaks shall not occur.

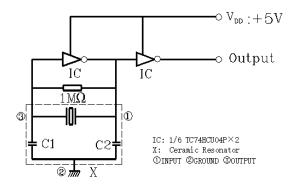
### Table 1

Item	Specification after test		
Oscillation Frequency Change △Fosc/Fosc (%) max	±0.3		
Resonant Impedance (Ω) max	40		
The limits in the above table are referenced to the initial measurements.			

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### **SMD CERAMIC RESONATOR CRTV SERIES**

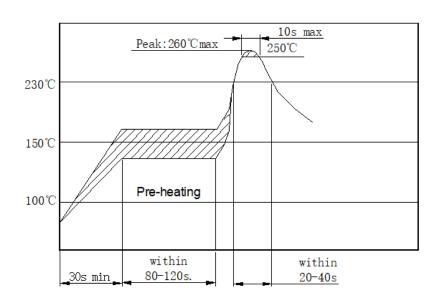
### **TEST CIRCUIT (For Reference Only)**



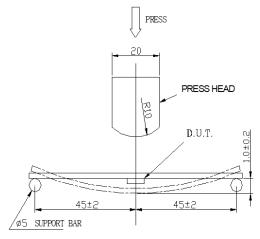
#### Note:

Parts shall be tested under the condition (Temp.: 20±15°C, Humidity 65±20% R.H.) unless the standard condition(Temp.: 25±3 °C, Humidity :65±10% R.H.) is regulated to measure.

### **SUGGESTED REFLOW PROFILE (For Reference Only)**



### **BOARD BENDING TEST- FIGURE 1**

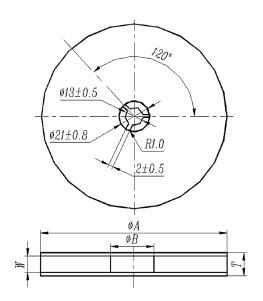




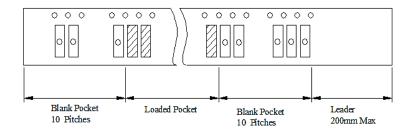
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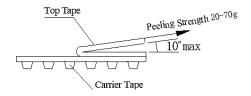
### TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications., 1000pcs/Reel



Symbol	Dimension
фА	180±3.0
фВ	60.0 Min.
W	12.4 Min.
Т	19.4 Max.





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